BOURNS®

SingIFuse™ SF-1206HIxxxM Series Features

- Single blow fuse for overcurrent protection
- 3216 (EIA 1206) footprint
- High inrush current withstand fuse
- UL 248-14 listed
- RoHS compliant* and halogen free**
- Multilayer SMD design
- Surface mount packaging for automated assembly

SF-1206HIxxxM Series - High Inrush Multilayer Surface Mount Fuses

Electrical Characteristics

Model	Rated Current (Amps)	Fusing Time	Resistance (Ω) Typ.***	Rated Voltage	Interrupting Rating	Typical I^2t (A^2s) ****
SF-1206HI100M-2	1.00	Open within 60 sec. at 200 % rated current	0.340	DC 63 V	DC 63 V 50 A	0.11
SF-1206HI150M-2	1.50		0.150			0.33
SF-1206HI200M-2	2.00		0.090			0.80
SF-1206HI250M-2	2.50		0.065	DC 32 V	DC 32 V 50 A	1.19
SF-1206HI300M-2	3.00		0.035			1.35
SF-1206HI350M-2	3.50		0.029			1.84
SF-1206HI400M-2	4.00		0.023			2.74
SF-1206HI450M-2	4.50		0.021			3.20
SF-1206HI500M-2	5.00		0.017			5.50
SF-1206HI600M-2	6.00		0.013	DC 24 V	DC 24 V 80 A	12.50
SF-1206HI700M-2	7.00		0.010			30.00
SF-1206HI800M-2	8.00		0.009			60.00

*** Resistance value measured with ≤10 % rated current at 25 °C ambient.
**** Melting I^2t calculated at 1000 % of current rating.

Reliability Testing

No.	Test	Requirement	Test Condition	Test Reference
1	Solderability	Minimum 95 % coverage	One dip at 245 °C for 5 seconds	MIL-STD-202 Method 208
2	Soldering heat resistance	DCR change ≤ 10 % No mechanical damage	One dip at 260 °C for 60 seconds	MIL-STD-202 Method 210
3	Moisture resistance	DCR change ≤ ±15 % No excessive corrosion	10 cycles	MIL-STD-202 Method 106
4	Salt spray	DCR change ≤ ±10 % No excessive corrosion	48 hour exposure, 5 % salt solution	MIL-STD-202 Method 101
5	Mechanical vibration	DCR change ≤ ±10 % No mechanical damage	0.4 inch D.A. or 30 G between 5-3000 Hz	MIL-STD-202 Method 204
6	Mechanical shock	DCR change ≤ ±10 % No mechanical damage	1500 G, 0.5 ms, half-sine shocks	MIL-STD-202 Method 213
7	Thermal Shock	DCR change ≤ ±10 % No mechanical damage	100 cycles between -65 °C and +125 °C	MIL-STD-202 Method 107
8	Life	No electrical “opens” during testing Voltage drop change shall be less than ±20 % of initial value	80 % rated current (75 % for < 1 A fuses) for 2000 hours at ambient temperature between +20 °C and +30 °C	Refer to STP document

Agency Recognition

UL File Number E198545

http://www.ul.com/ Follow link to Online Certificates Directory, then enter UL File No. E198545, or click here

BOURNS®

Asia-Pacific: Tel: +886-2 2562-4117 • Email: asiacus@bourns.com
EMEA: Tel: +36 88 520 390 • Email: eurocus@bourns.com
The Americas: Tel: +1-951 781-5500 • Email: americus@bourns.com
www.bourns.com

* RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.
** Bourns considers a product to be “halogen free” if (a) the Bromine (Br) content is 900 ppm or less; (b) the Chlorine (Cl) content is 900 ppm or less; and (c) the total Bromine (Br) and Chlorine (Cl) content is 1500 ppm or less.

“SingIFuse” is a trademark of Bourns, Inc.
Specifications are subject to change without notice.
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
Users should verify actual device performance in their specific applications.

SingIFuse™ SF-1206HIxxxM Series Applications

- Portable memory
- LCD monitors
- Disk drives
- PDAs
- Digital cameras
- MP3 players
- Cell phones
- Rechargeable battery packs
- Battery chargers
- Set-top boxes
- Industrial controllers
- Battery Management Systems (BMS)
- LED lighting
- Power tools

SF-1206HIxxxM Series - High Inrush Multilayer Surface Mount Fuses

BOURNS®

Environmental Characteristics

Operating Temperature.....-55 °C to +150 °C
Storage Conditions
Temperature .....+5 °C to +35 °C
Humidity.....40 % to 75 %
Shelf Life.....2 years from manufacturing date
Moisture Sensitivity Level 1
ESD Classification (HBM)..... Class 6

Typical Part Marking

Represents total content. Layout may vary.

RATED CURRENT (A)

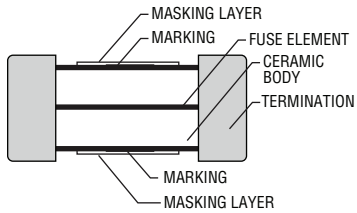
E = 1.00	M = 4.00
G = 1.50	T = 4.50
I = 2.00	N = 5.00
J = 2.50	O = 6.00
K = 3.00	P = 7.00
L = 3.50	R = 8.00

How to Order

SF - 1206 HI 100 M - 2

SingIFuse™ Product Designator
SMD Footprint
1206 = 3216 (EIA 1206) size
Fuse Blow Type
HI = High Inrush Capability
Rated Current
100 ~ 800 (1.0 A ~ 8.0 A)
Structure Type
M = Multilayer
Packaging Type
- 2 = Tape & Reel

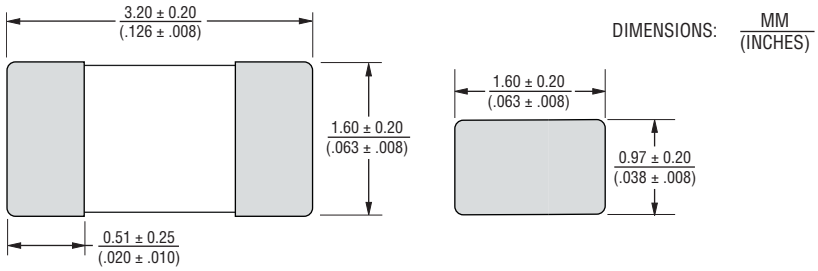
Construction



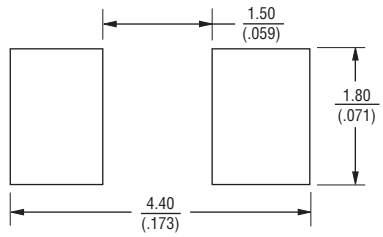
Packaging Quantity

3,000 pieces per 7-inch reel

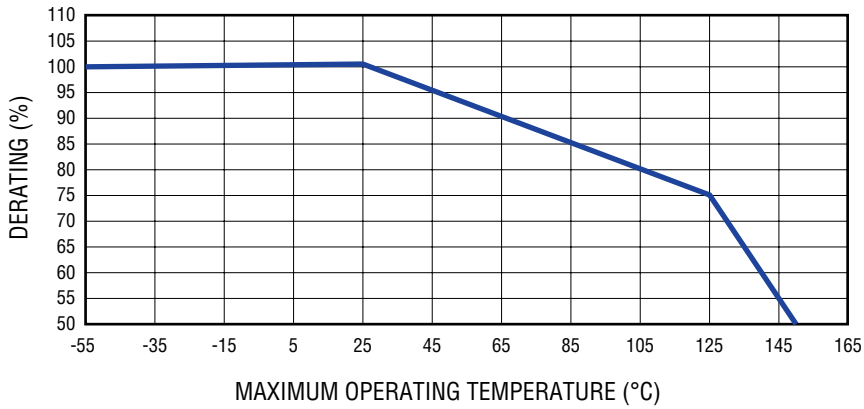
Product Dimensions



Recommended Pad Layout

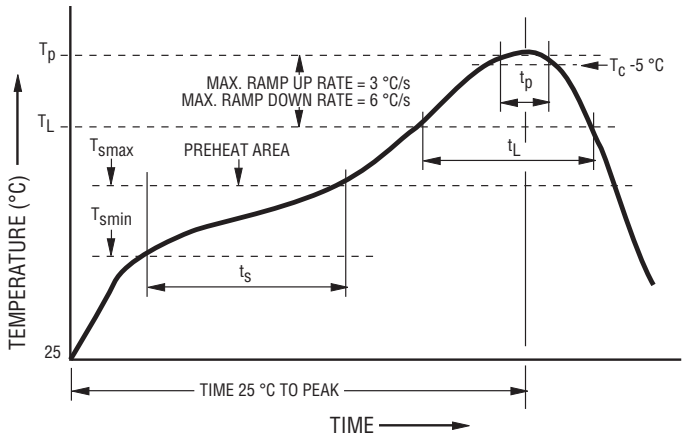


Current Rating Thermal Derating Curve



Specifications are subject to change without notice.
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
Users should verify actual device performance in their specific applications.

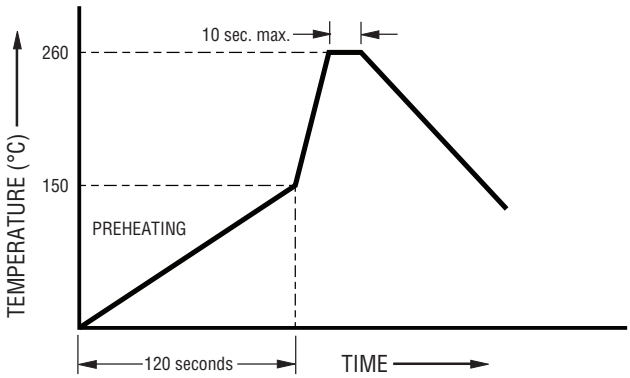
Solder Reflow Recommendations



Profile Feature	Pb-Free Assembly
Preheat / Soak: Temperature Min. (T_{smin}) Temperature Max. (T_{smax}) Time (t_s) from (T_{smin} to T_{smax})	 150 °C 200 °C 60~120 seconds
Ramp Up Rate (T_L to T_p)	3 °C / second max.
Liquidous Temperature (T_L) Time (t_L) maintained above T_L	217 °C 60~150 seconds
Peak Package Body Temperature (T_p)	260 °C
Time (t_p)* within 5 °C of the specified classification temperature (T_c)	30 seconds*
Ramp Down Rate (T_p to T_L)	6 °C / second max.
Time 25 °C to Peak Temperature	8 minutes max.

* Tolerance for peak profile temperature (Tp) is defined as a supplier minimum and a user maximum.

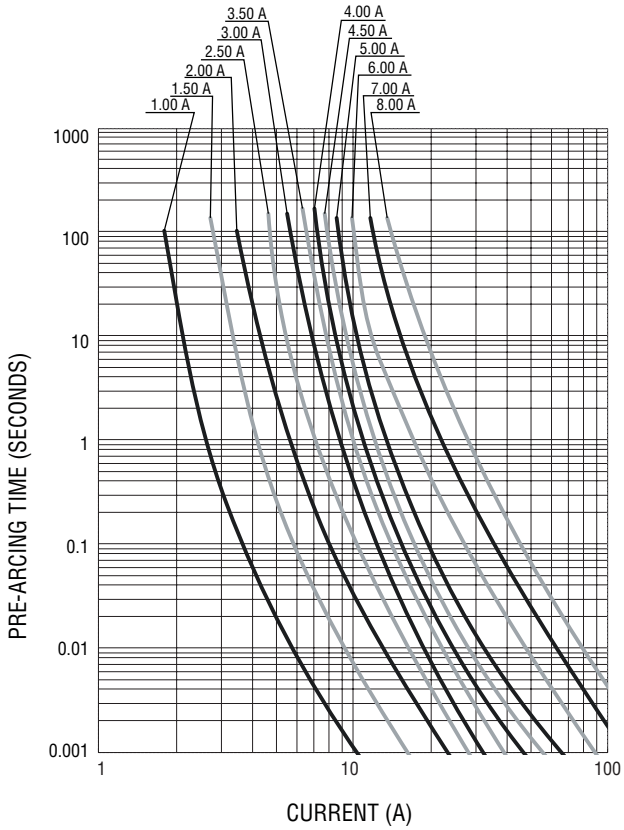
Recommended Temperature Profile for Wave Soldering



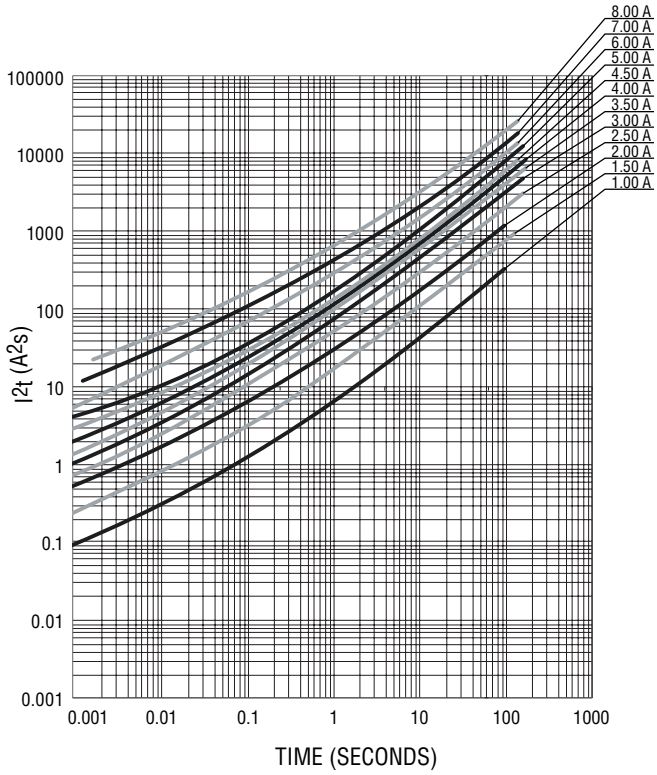
Wave soldering is suitable for 1206 size models.

Specifications are subject to change without notice.
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
Users should verify actual device performance in their specific applications.

Average Pre-Arcing Time vs. Current Curves



Average I^2t vs. t Curves



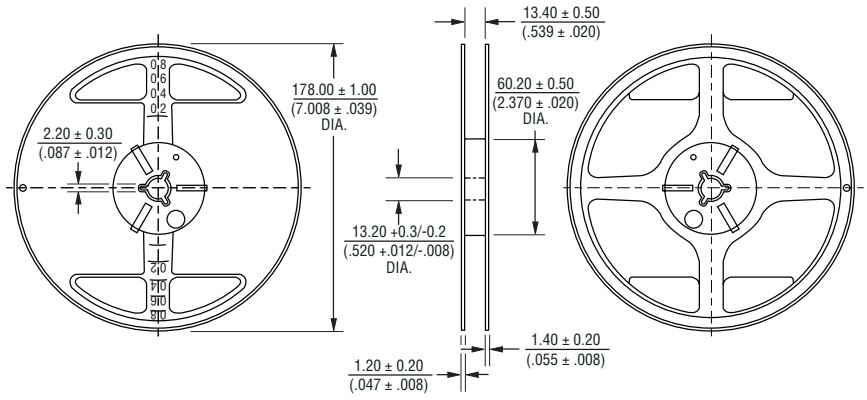
Specifications are subject to change without notice.
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
Users should verify actual device performance in their specific applications.

SF-1206HIxxxM Series Tape and Reel Packaging Specifications

BOURNS®

Tape Dimensions	SF-1206HIxxxM Series per EIA 481-2
W	8.00 ± 0.10 (.315 ± .004)
P_0	4.0 ± 0.10 (.157 ± .004)
P_1	4.0 ± 0.10 (.157 ± .004)
P_2	2.0 ± 0.05 (.079 ± .002)
A_0	1.80 ± 0.10 (.071 ± .004)
B_0	3.50 ± 0.10 (.138 ± .004)
F	3.50 ± 0.05 (.138 ± .002)
E_1	1.75 ± 0.10 (.069 ± .004)
D_0	1.50 ± 0.10 (.059 + .004)
K_0	1.10 + 0.10 (.043 + .004)
T	0.23 ± 0.02 (.009 ± .001)

PACKAGING: Plastic tape, 3,000 pcs. per reel



DIMENSIONS: MM / (INCHES)

Specifications are subject to change without notice.
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time.
Users should verify actual device performance in their specific applications.

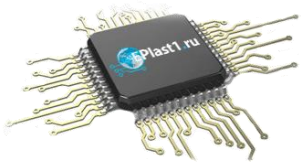
Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits,General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

Телефон: 8 (812) 309 58 32 (многоканальный)
Факс: 8 (812) 320-02-42
Электронная почта: org@eplast1.ru
Адрес: 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.